

Fig. 2 - Dimensional outline

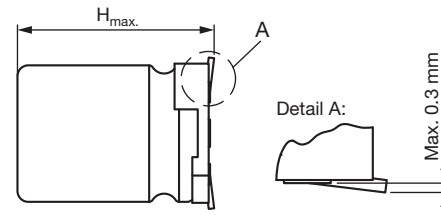


Fig. 3 - Coplanarity of pins

Table 1

| DIMENSIONS in millimeters AND MASS | | | | | | | | | |
|--|--------------|-------------------|-------------------|-------------------|------|-------------------|-----|--------------------|-------------|
| NOMINAL CASE SIZE L x W x H | CASE CODE | L _{MAX.} | W _{MAX.} | H _{MAX.} | Ø D | B _{MAX.} | S | L1 _{MAX.} | MASS (g) |
| 5.0 x 5.0 x 5.8 | 0506 | 5.5 | 5.5 | 6.1 | 5.0 | 0.8 | 1.4 | 6.1 | 0.2 |
| 6.3 x 6.3 x 5.8 | 0606 | 6.8 | 6.8 | 6.1 | 6.3 | 0.8 | 2.2 | 7.4 | 0.3 |
| 6.3 x 6.3 x 7.7 | 0608 | 6.8 | 6.8 | 8.0 | 6.3 | 0.8 | 2.2 | 7.4 | 0.4 |
| 8.0 x 8.0 x 10.5 | 0810 | 8.5 | 8.5 | 10.8 | 8.0 | 1.1 | 3.1 | 9.2 | 0.9 |
| 10.0 x 10.0 x 10.5 | 1010 | 10.5 | 10.5 | 10.8 | 10.0 | 1.1 | 4.5 | 11.2 | 1.2 |
| 10.0 x 10.0 x 16.5 | 1016 | 10.5 | 10.5 | 16.8 | 10.0 | 1.4 | 4.5 | 11.2 | 1.8 |

Table 2

| TAPE AND REEL DIMENSIONS in millimeters, PACKAGING QUANTITIES | | | | | | |
|---|--------------|-------------------------|-----------------|-------------------------------------|---------------|-----------------------------------|
| NOMINAL CASE SIZE L x W x H | CASE CODE | PITCH P ₁ | TAPE WIDTH W | TAPE THICKNESS T ₂ | REEL DIAMETER | PACKAGING QUANTITY PER REEL |
| 5.0 x 5.0 x 5.8 | 0506 | 12 | 12 | 6.1 | 380 | 1000 |
| 6.3 x 6.3 x 5.8 | 0606 | 12 | 16 | 5.7 | 380 | 1000 |
| 6.3 x 6.3 x 7.7 | 0608 | 12 | 16 | 8.0 | 380 | 900 |
| 8.0 x 8.0 x 10.5 | 0810 | 16 | 24 | 11.0 | 380 | 500 |
| 10.0 x 10.0 x 10.5 | 1010 | 16 | 24 | 11.0 | 380 | 500 |
| 10.0 x 10.0 x 16.5 | 1016 | 16 | 24 | 17.5 | 380 | 250 |

MOUNTING

The capacitors are designed for automatic placement on to printed-circuit boards.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print layout and / or adjacent components.

For recommended soldering pad dimensions, refer to Fig. 4 and Table 3.

SOLDERING

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the component during processing.

For maximum conditions refer to Fig. 5.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

As a general principle, temperature and duration shall be the **minimum** necessary required to ensure good soldering connections. However, the specified maximum curves should never be exceeded.

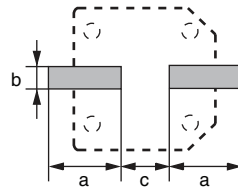


Fig. 4 - Recommended soldering pad dimensions

Table 3

| RECOMMENDED SOLDERING PAD DIMENSIONS in millimeters | | | | |
|--|-----------|-----|-----|-----|
| NOMINAL CASE SIZE L x W x H | CASE CODE | a | b | c |
| 5.0 x 5.0 x 5.8 | 0506 | 3.0 | 1.6 | 1.4 |
| 6.3 x 6.3 x 5.8 | 0606 | 3.5 | 1.6 | 2.1 |
| 6.3 x 6.3 x 7.7 | 0608 | 3.5 | 1.6 | 2.1 |
| 8.0 x 8.0 x 10.5 | 0810 | 4.2 | 1.9 | 2.8 |
| 10.0 x 10.0 x 10.5 | 1010 | 4.4 | 1.9 | 4.3 |
| 10.0 x 10.0 x 16.5 | 1016 | 4.4 | 2.2 | 4.3 |

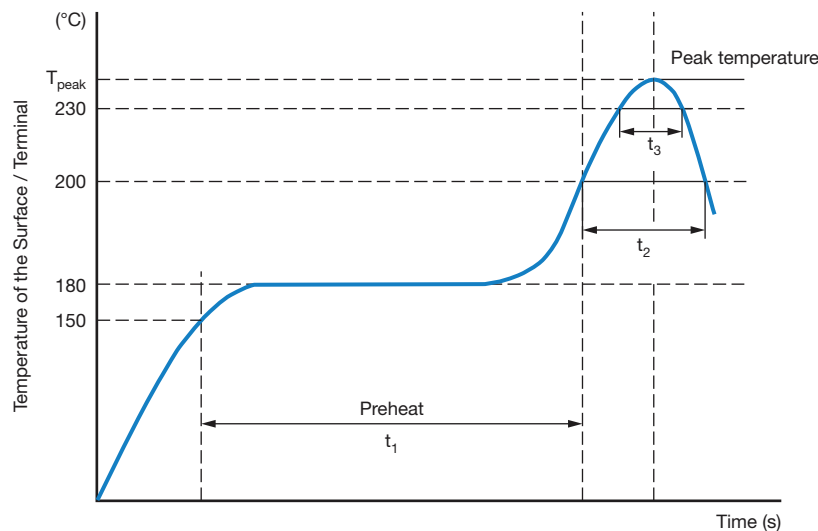
SOLDERING PROFILE FOR LEAD (Pb)-FREE REFLOW PROCESS


Fig. 5 - Maximum temperature load during reflow soldering

Table 4

| REFLOW SOLDERING CONDITIONS for MAL2183xxxxxE3 | | | |
|---|-----------------------------------|---------------------------------|--------|
| PROFILE FEATURES | $\varnothing \leq 6.3 \text{ mm}$ | $\varnothing \geq 8 \text{ mm}$ | |
| Maximum time between 150 °C to 200 °C (t_1) | 120 s | 120 s | |
| Ramp up rate from 217 °C to T_{peak} | 0.5 K/s to 3 K/s | | |
| Maximum time above 200 °C (t_2) | 70 s | 70 s | |
| Maximum time above 230 °C (t_3) | 30 s | 30 s | |
| Maximum time above liquidus (217 °C) | 40 s | 40 s | |
| Peak temperature T_{Peak} | 260 °C | 260 °C | 245 °C |
| Maximum reflow cycles | 2 | 1 | 2 |
| Maximum time within 5 °C below T_{peak} | 5 | 5 | 10 |
| Ramp down rate T_{peak} to 217 °C | 6 K/s max. | | |
| Time 25 °C to T_{Peak} | 8 min max. | | |

Note

- Temperature measuring point on top of the case and on terminals



USEFUL LIFE AND ENDURANCE

Table 7

| ENDURANCE TEST AND USEFUL LIFE | | | | | | | |
|--------------------------------|--------------|--|-------------------------|-------------------------|------------------------|------------------------|------------------------|
| SERIES | CASE CODE | USEFUL LIFE AT 125 °C (h) ⁽¹⁾ | ENDURANCE AT 125 °C (h) | ENDURANCE AT 105 °C (h) | ENDURANCE AT 85 °C (h) | ENDURANCE AT 75 °C (h) | ENDURANCE AT 65 °C (h) |
| 183 CPHT | 0506 to 1016 | 4000 | 4000 | 16 000 | 64 000 | 128 000 | 256 000 |

Note

⁽¹⁾ Identical with endurance for this series

Endurance can be calculated by formula below:

$$L = L_{T_{max.}} \times 2^{\frac{T_{max.} - T_a}{10}}$$

L: estimated lifetime (h)

$L_{T_{max.}}$: base lifetime specified at maximum operating temperature with applied DC voltage (h)

$T_{max.}$: rated maximum operating temperature (°C)

T_a : actual ambient temperature (°C)

Table 8

| MULTIPLIER OF RIPPLE CURRENT (I_R) AS A FUNCTION OF FREQUENCY | | | |
|---|------|--------|-----------|
| FREQUENCY (Hz) | | | |
| 120 | 1000 | 10 000 | ≥ 100 000 |
| I_R MULTIPLIER | | | |
| 0.1 | 0.3 | 0.6 | 1 |

Table 9

| TEST PROCEDURES AND REQUIREMENTS | | | |
|---|---|--|---|
| TEST | | PROCEDURE (quick reference) | REQUIREMENTS |
| NAME OF TEST | REFERENCE | | |
| Mounting | IEC 60384-25, subclause 4.3 | Shall be performed prior to tests mentioned below; reflow soldering; for maximum temperature load refer to chapter "Mounting" | $\Delta C/C: \pm 5 \%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ |
| Endurance | IEC 60384-25 / CECC 32300, subclause 4.15 | $T_{amb} = 125 \text{ °C}$; U_R applied; for test duration see Table 7 | $\Delta C/C: \pm 30 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ $ESR \leq 2 \times \text{spec. limit}$ |
| Useful life | CECC 30301, subclause 1.8.1 | $T_{amb} = 125 \text{ °C}$; U_R and I_R applied; for test duration see Table 7 | $\Delta C/C: \pm 30 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ $ESR \leq 2 \times \text{spec. limit}$ |
| Shelf life (storage at high temperature) | IEC 60384-25 / CECC 32300, subclause 4.16 | $T_{amb} = 125 \text{ °C}$; no voltage applied; 1000 h after test: U_R to be applied for 30 min, 24 h to 48 h before measurement | For requirements see "Endurance test" above |

Statements about product lifetime are based on calculations and internal testing. They should only be interpreted as estimations. Also due to external factors, the lifetime in the field application may deviate from the calculated lifetime. In general, nothing stated herein shall be construed as a guarantee of durability.



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